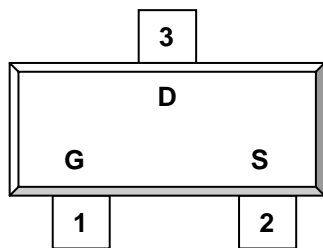
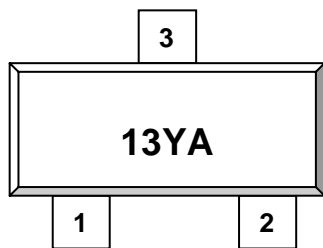


DESCRIPTION

The STP3413 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other batter powered circuits where high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

**PIN CONFIGURATION
SOT-23-3L**


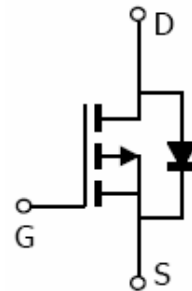
1. Gate 2. Source 3. Drain

**PART MARKING
SOT-23-3L**


Y: Year Code A: Process Code

FEATURE

- -20V/-3.4A, $R_{DS(ON)} = 95\text{m-ohm}$ @VGS = -4.5V
- -20V/-2.4A, $R_{DS(ON)} = 120\text{m-ohm}$ @VGS = -2.5V
- -20V/-1.7A, $R_{DS(ON)} = 145\text{m-ohm}$ @VGS = -1.8
- -20V/-1.0A, $R_{DS(ON)} = 210\text{m-ohm}$ @VGS = -1.25V
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23-3L package design



ORDERING INFORMATION

Part Number	Package	Part Marking
ST3413S23RG	SOT-23-3L	13YA

※ Process Code : A ~ Z ; a ~ z

※ ST3413S23RG S23 : SOT-23-3L ; R : Tape Reel ; G : Pb – Free



ST3413 

P Channel Enhancement Mode MOSFET

-3.4A

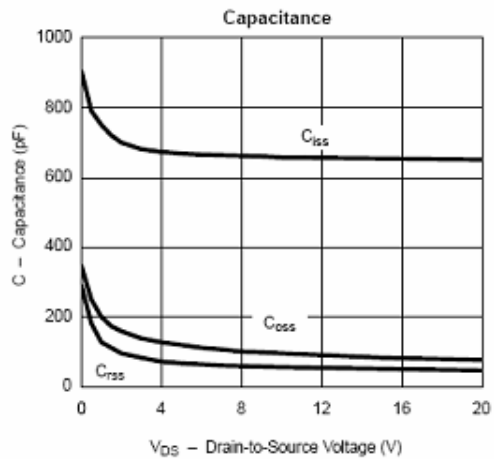
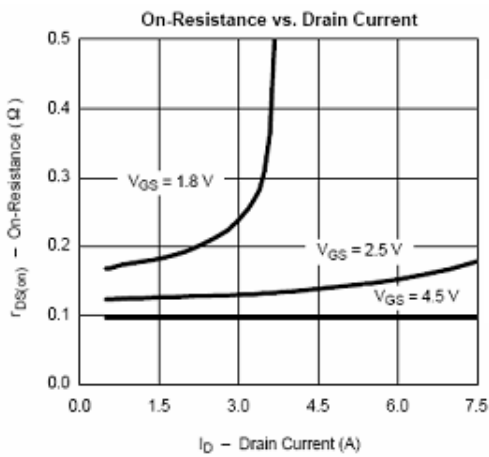
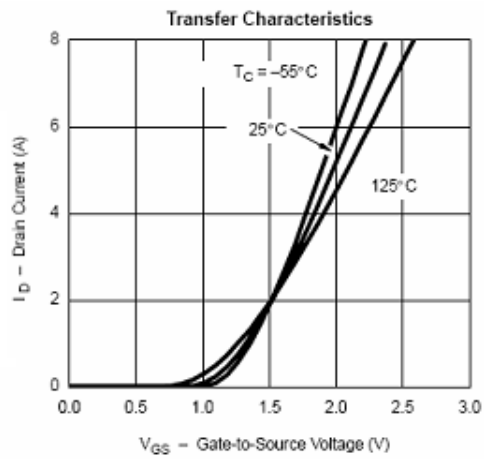
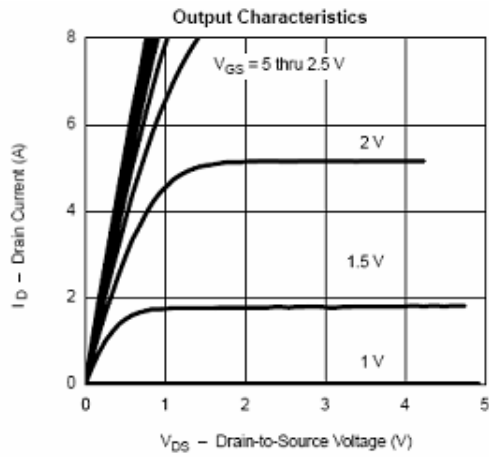
ABSOLUTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-20	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current (T _J =150°C)	I _D	T _A =25°C -3.5	A
		T _A =70°C -2.8	
Pulsed Drain Current	I _{DM}	-15	A
Continuous Source Current (Diode Conduction)	I _S	-1.4	A
Power Dissipation	P _D	T _A =25°C 1.25	W
		T _A =70°C 0.8	
Operation Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	105	°C/W

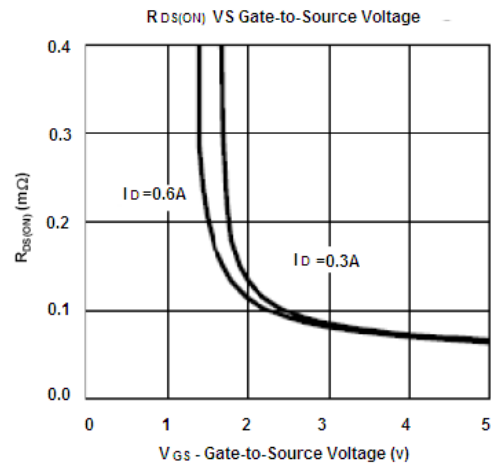
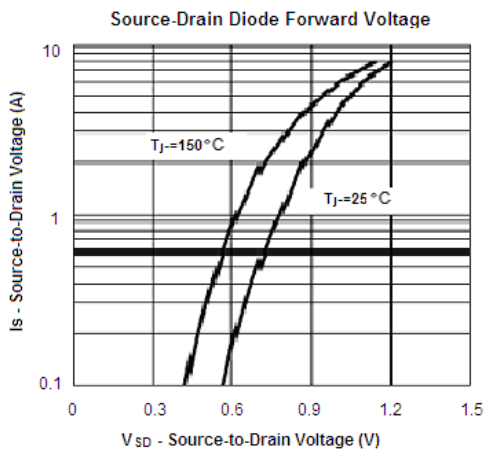
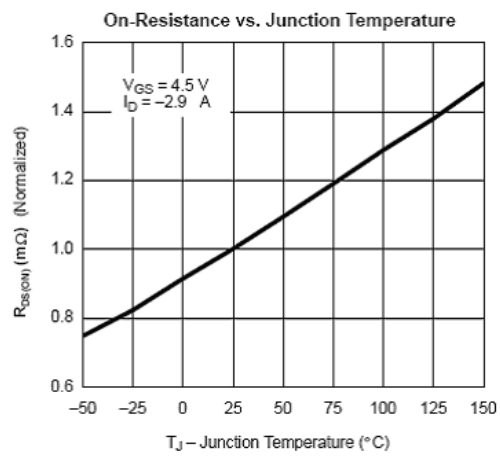
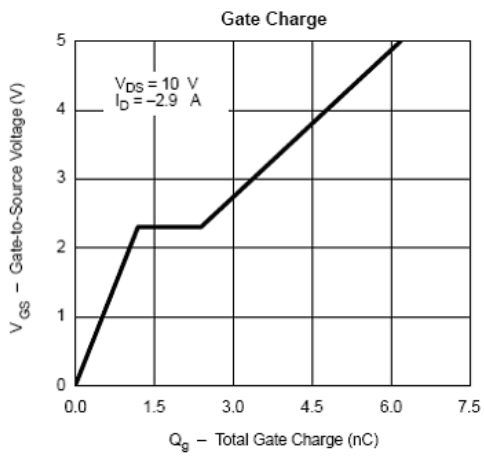
ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	0.35		0.8	V
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$			± 100	Na
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-20V, V_{GS}=0V$			-1	UA
		$V_{DS}=-20V, V_{GS}=0V$ $T_J=55^\circ C$			-5	
On-State Drain Current	$I_{D(on)}$	$V_{DS}\leq -5V, V_{GS}=-45V$	-6.0			A
Drain-source On-Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-3.4A$		0.076	0.095	Ω
		$V_{GS}=-2.5V, I_D=-2.4A$		0.097	0.120	
		$V_{GS}=-1.8V, I_D=-1.7A$		0.123	0.145	
		$V_{GS}=-1.25V, I_D=-1.0A$		0.185	0.210	
Forward Transconductance	g_{fs}	$V_{DS}=-5.0V, I_D=-2.8A$		6		S
Diode Forward Voltage	V_{SD}	$I_S=-1.6A, V_{GS}=0V$		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=-6.0V$ $V_{GS}=-4.5V$ $I_D=-2.8A$		4.8	8	nC
Gate-Source Charge	Q_{gs}			1.0		
Gate-Drain Charge	Q_{gd}			1.0		
Input Capacitance	C_{iss}	$V_{DS}=-6.0V$ $V_{GS}=0V$ $F=1MHz$		485		pF
Output Capacitance	C_{oss}			85		
Reverse Transfer Capacitance	C_{rss}			40		
Turn-On Time	$t_{d(on)}$ t_r	$V_{DD}=6.0V$ $R_L=6.0\Omega$ $I_D=1.0A$ $V_{GEN}=-4.5V$ $R_G=6\Omega$		10	16	nS
				13	22	
Turn-Off Time	$t_{d(off)}$ t_f			18	24	
				15	20	

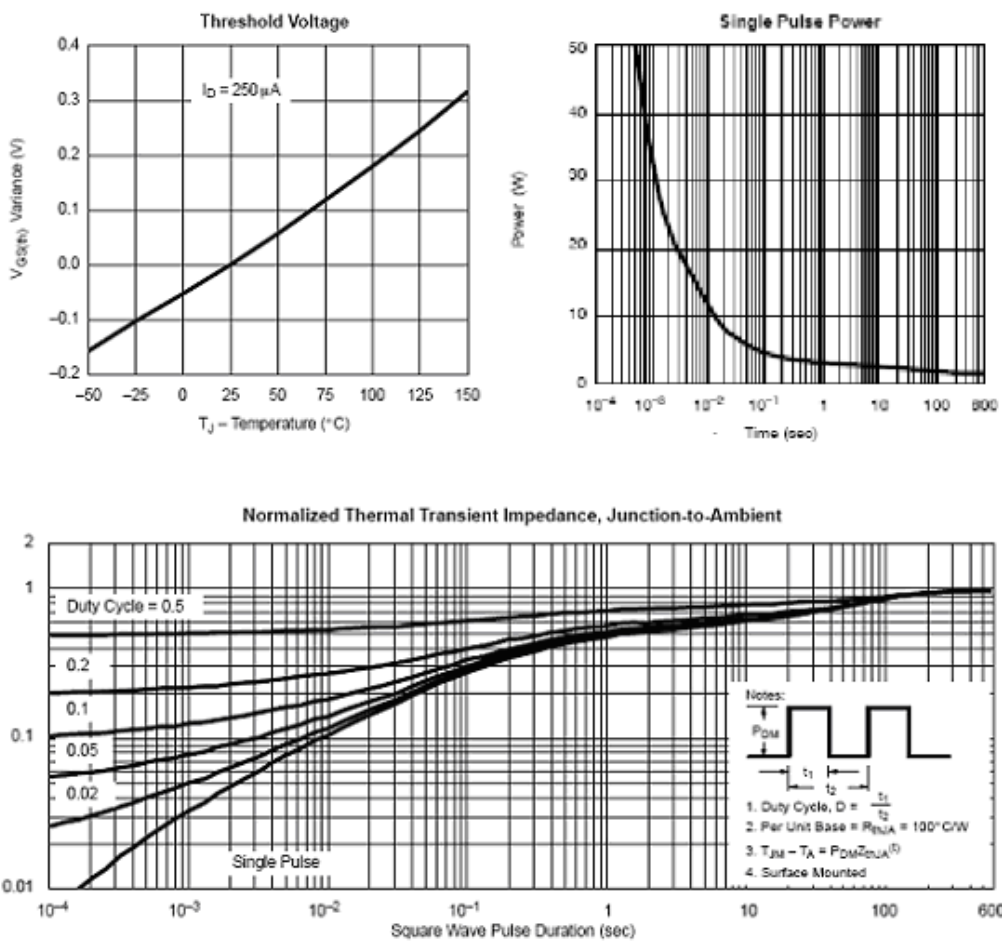
TYPICAL CHARACTERISTICS (25°C Unless noted)



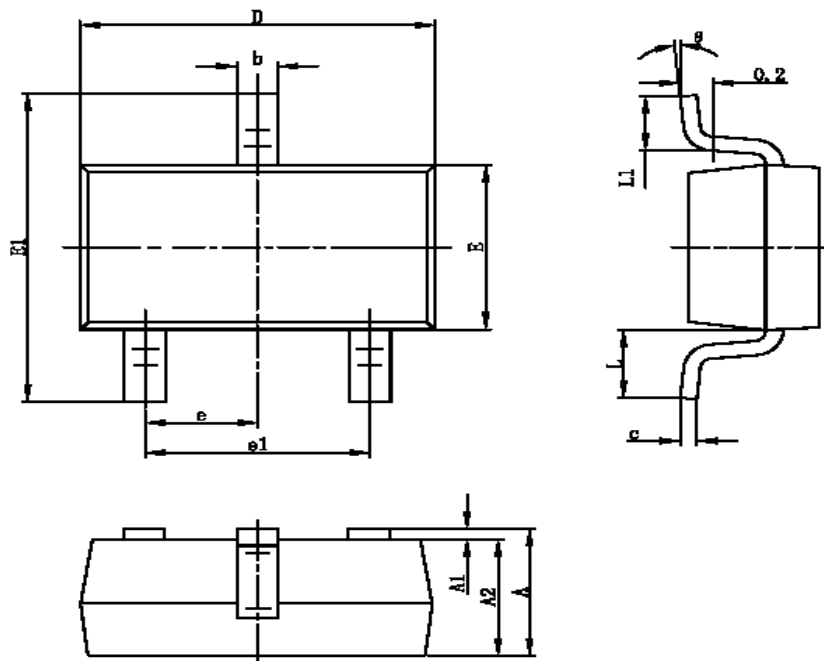
TYPICAL CHARACTERISTICS (25°C Unless noted)




TYPICAL CHARACTERISTICS (25°C Unless noted)



SOT-23-3L PACKAGE OUTLINE





ST3413 

P Channel Enhancement Mode MOSFET

-3.4A

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°